## □ MN101D06F , MN101D06G , MN101D06H

VTR Servo

Туре	MN101D06F	MN101D06G	MN101D06H		
ROM (×8-bit)	96 K 128 K 160		160 K		
RAM (×8-bit)	3 K	4 K	5 K		
Package	QFP100-P-1818B *Lead-free				
Minimum Instruction Execution Time	With main clock operated0.1397 μs (at 4.0 V to 5.5 V, 14.32 MHz)When sub-clock operated71.5 μs (at 3.0 V to 5.5 V fixed to 14.32 MHz internal frequency division)61 μs (at 2.2 V to 5.5 V, 32.768 kHz)				
Interrupts	<ul> <li>RESET • Runaway • External 0, 1, 2, 3, 4/key input (P50 to 54) • Timer 0 • Timer 1 • Timer 2 • Timer 3</li> <li>Timer 4 • Timer 6 • Capstan FG • Control • HSW • Cylinder FG • Servo VSYNC • Synchronous output</li> <li>• OSD • XDS • Serial 0 • Serial 1 • Serial 2 • A/D (common with PWM 4 reference frequency)</li> <li>• OSDVSYNC</li> </ul>				
Timer Counter	Timer counter 0: 16-bit × 1 (timer function, clock function [max. 2 s or max. 36 h at cascade-connecting with timer 6]) Clock source				
	Timer counter 1: 16-bit × 1 (timer function, linear timer counter function) Clock source				
	Clock source ······ 1/2 Interrupt source ····· ove shi	ction, input capture (DCTL specified ed , 1/4, 1/8, 1/12, 1/16, 1/24 of system cl erflow of timer counter 2; input of DCT ft register 4-bit counter; coincidence of ister compare register	ock frequency L specified edge; underflow of timer		
		ndexing, generation of remote control of , 1/4, 1/8, 1/16 of system clock frequence rflow of timer counter 3			
	Clock source ······ 1/8	ction, event count [P15 input], generation, 1/16 of system clock frequency; exter orflow of timer counter 4; coincidence o	nal clock input		
	Clock sourcesys Watchdog interrupt source 1/2	og, stable oscillation waiting function) tem clock <sup>16</sup> , 1/2 <sup>19</sup> of timer counter 5 frequency er 256 counts by timer counter 5 (2 <sup>18</sup> co			
	1/4	ction [max. 2 s]) 12 of OSC oscillation clock frequency; , 1/8, 1/64, 1/128 of system clock frequ <sup>13</sup> , 1/2 <sup>14</sup> , 1/2 <sup>15</sup> overflow of timer counter	iency		
	Timer counter 7: 8-bit × 1 (timer func Clock source	, 1/8, 1/16, 1/32 of system clock freque	ncy; external clock input		
Serial Interface	Synchronous type clock source · 1/4 2-d	start-stop synchronous type) (transfer di , 1/8, 1/16, 1/32, 1/64, 1/128, 1/256 of ivision timer 4 output; SBT0 pin input ivision of above clock; 2-division timer	system clock frequency;		

Serial Interface (Continue)	Serial 1: 8-bit × 1	
	(synchronous type/remote control trans	mission/simple remote control receive) (transfer direction of MSB/LSB
	selectable, start condition function)	
	Clock source 1/8, 1/	/16, 1/32, 1/64, 1/128, 1/256 of system clock frequency;
	2-divi	sion timer 4 outpu <del>t; SBT</del> 1 pin input
	Remote control clock 2-divi	sion timer 4 output
	Serial 2: 8-bit × 1 (I <sup>2</sup> C) (master transmi	ssion/reception, slave transmission/reception)
	Clock source 1/144	to 1/252 of system clock; SCK pin input
OSD	OSD mode:Accommodation with menu	or super impose display
	Applicable broadcasting sys	tem : NTSC, PAL, PAL-M, PAL-N
	Screen configuration	: 24 characters $\times$ 2n rows (n = 1 to 6)
	Character type	: max. 512 character types (variable)
	Character size	: $12 \times 18$ dots (Vertical direction: 1 dot for 2H at $\times 1$ setting.)
	Enlarged characters	: each $\times$ 2, $\times$ 3 or $\times$ 4 settings in horizontal and vertical
	Character interpolation	: none
	Line background color	: 8-hue settable (settable in the row unit at menu display)
	Line background intensity	: 8 gradations settable in the row unit
	Screen background color	: 8-hue settable (at output of composite video signal)
	Character color	: white
	Character intensity	: 8 gradations settable in the row unit
	Frame function	: 1-dot frame in 4 or 8 directions
	Frame intensity	: 4 gradations settable in the row unit
	Box shade function	: settable in the character unit (at output of composite video signal with 129 or more characters (character types))
	Blinking	: none (covered by software)
	Inverted character	: settable in the character unit
	Halftone	: settable in the row unit in 2 intensity gradations (at output of
	CCD mode: Supports Closed Caption	external synchronous composite video signal)
	Screen configuration	: 32 characters $\times$ 16 rows
	Character type	: max. 128 character types (variable)
	Character size	: $12 \times 26$ dots (Vertical direction: 1 dot for 1H, including 8 dots in the
		underlined area)
	Enlarged characters	: none
	Character interpolation	: none
	Line background color	: 8-hue settable
	Line background intensity	: 8 gradations settable in the screen unit (at output of composite video signal)
	Screen background color	: 8-hue settable (at output of composite video signal)
	Character color	: 8 colors (at RGB output)
		: White (at output of composite video signal)
	Character intensity	: 8 gradations settable in the screen unit
	Frame function	: none
	Box shade function	: none
	Inverted character	: none
	Halftone	: settable in the row unit in 2 intensity gradations
		(at output of external synchronous composite video signal)
	Others	: Underline, italic, blinking function and scroll
	Input Clamp method	: composite video signal input (output level: 1 V[p-p] / 2 V[p-p])
	Clamp method Output	: sync chip clamp, clamp level in 4 levels : composite video output
	Julput	: digital output (6 pins)
	Measure against image fluctuation	: built-in AFC circuit
	Dot clock	: 1/2 of OSC oscillation clock (automatic phase adjustment)

XDS		Built-in U.S. closed caption data slicer (optional 2 line data can be extracted.)		
ROM Correct	ion	Correcting address designation: up to 3 addresses possible Correction method: correction program being saved in internal RAM		
I/O Pins	I/O	75         • Common use: 75 ports 0, 1, 2, 4, 5, 6, 7, A, B (by bit)		
	Input	2 • Common use: 2		
A/D Inputs		8-bit $\times$ 13-ch. (without S/H)		
PWM		13-bit × 2-ch. (at repetition cycle 572 μs, 14.32 MHz), 10-bit × 2-ch. (at repetition cycle 71.5 μs, 14.32 MHz), 8-bit × 1-ch. (at repetition cycle 35.7 μs, 14.32 M		
ICR		$18$ -bit $\times$ 6-ch.		
OCR		16-bit × 7-ch. , 8-bit × 1-ch.		
Special Ports		Buzzer output; 3-state output (PTO) VLP pin; synchronous output: 7; 3-state synchronous output: 4; remote control receive; CTL amp; built-in FG amp; output of 1/2 OSC oscillation clock (2 V[p-p]); output of 1/4 OSC oscillation clock (1 V[p-p])		
Notes		VISS/VASS detection function		

Electrical Characteristics

Supply current

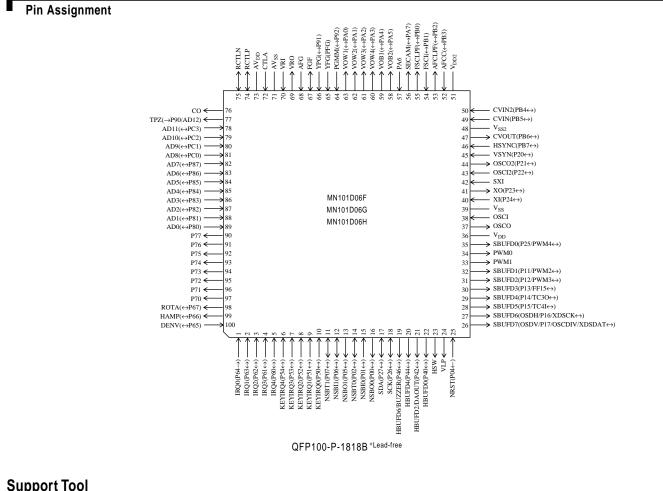
Parameter	Symbol	Condition	on Limit	Unit		
Falameter	Symbol	Condition		typ	max	Unit
	IDD1	14.32 MHz operation without load, $VDD = 5 V$		60	100	mA
Operating supply current	IDD2	1/1024 of 14.32 MHz operation without load, VDD = 3.0 V		2	5	mA
Operating Supply current	IDD3	Stop of 14.32 MHz oscillation, VDD = 2.7 V		50	100	μA
	1005	32 kHz oscillation operation without load		50	100	
Supply current at STOP	IDSP	Stop of oscillation without load, $VDD = 5 V$			20	μA
	IDHT0	14.32 MHz oscillation without load, $VDD = 5 V$		5	15	mA
Supply current at HALT	IDHT1	Stop of 14.32 MHz oscillation, VDD = 2.7 V		5	20	
		32 kHz oscillation operation without load		5	20	μΑ

 $(Ta = 25^{\circ}C \pm 2^{\circ}C, VSS = 0 V)$ 

## A/D Converter Performance

Parameter Syr	Symbol	ol Condition		Limit		
	Symbol		min	typ	max	Unit
Conversion relative error	ΔNLAD				± 3	LSB
A/D Conversion Time	tAD	fosc = 14.32 MHz		8		μs
Analog Input Voltage					5	v

 $(Ta=25^{\circ}C\pm2^{\circ}C$  , VDD=5.0~V , VSS=0~V)



Sup	port	Tool
-----	------	------

PX-ICE101C / D + PX-PRB101D06-QFP100-P-1818B-M	
Туре	MN101DF06K [ES (Engineering Sample) available]
ROM (× 8-bit)	224 К
RAM (× 8-bit)	6 K
Minimum instruction execution time	0.1397 µs (at 4.0 V to 5.5 V, 14.32 MHz)
	71.5 $\mu s$ (at 3.0 V to 5.5 V, fixed to 14.32 MHz internal division)
Package	QFP100-P-1818B *Lead-free
	Type ROM (× 8-bit) RAM (× 8-bit) Minimum instruction execution time

## Request for your special attention and precautions in using the technical information and semiconductors described in this material

- (1) An export permit needs to be obtained from the competent authorities of the Japanese Government if any of the products or technologies described in this material and controlled under the "Foreign Exchange and Foreign Trade Law" is to be exported or taken out of Japan.
- (2) The technical information described in this material is limited to showing representative characteristics and applied circuits examples of the products. It neither warrants non-infringement of intellectual property right or any other rights owned by our company or a third party, nor grants any license.
- (3) We are not liable for the infringement of rights owned by a third party arising out of the use of the product or technologies as described in this material.
- (4) The products described in this material are intended to be used for standard applications or general electronic equipment (such as office equipment, communications equipment, measuring instruments and household appliances).

Consult our sales staff in advance for information on the following applications:

- Special applications (such as for airplanes, aerospace, automobiles, traffic control equipment, combustion equipment, life support systems and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body.
- Any applications other than the standard applications intended.
- (5) The products and product specifications described in this material are subject to change without notice for modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.
- (6) When designing your equipment, comply with the guaranteed values, in particular those of maximum rating, the range of operating power supply voltage, and heat radiation characteristics. Otherwise, we will not be liable for any defect which may arise later in your equipment. Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
- (7) When using products for which damp-proof packing is required, observe the conditions (including shelf life and amount of time let standing of unsealed items) agreed upon when specification sheets are individually exchanged.
- (8) This material may be not reprinted or reproduced whether wholly or partially, without the prior written permission of Matsushita Electric Industrial Co., Ltd.